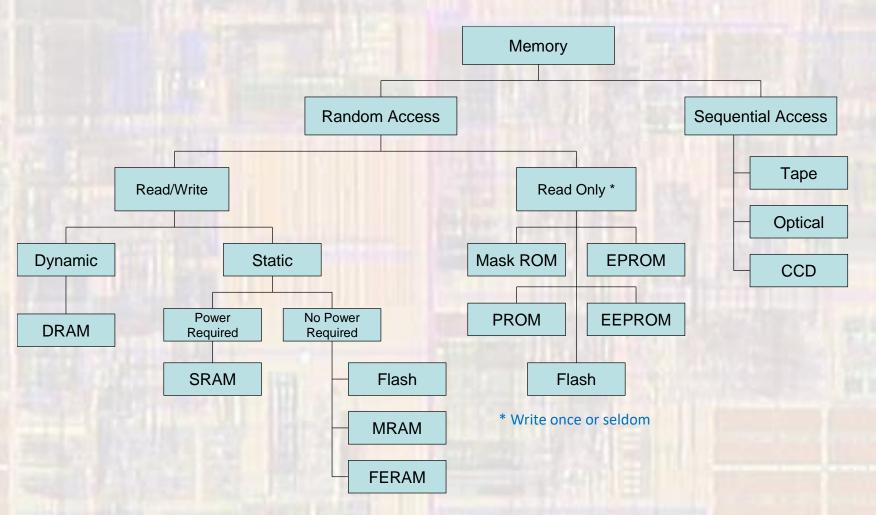
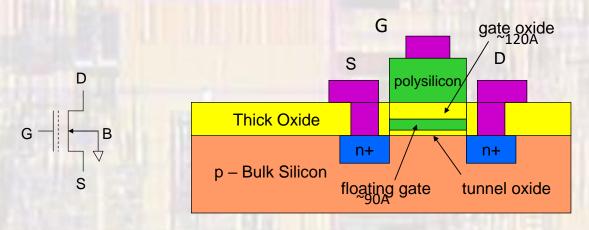
Last updated 2/8/24

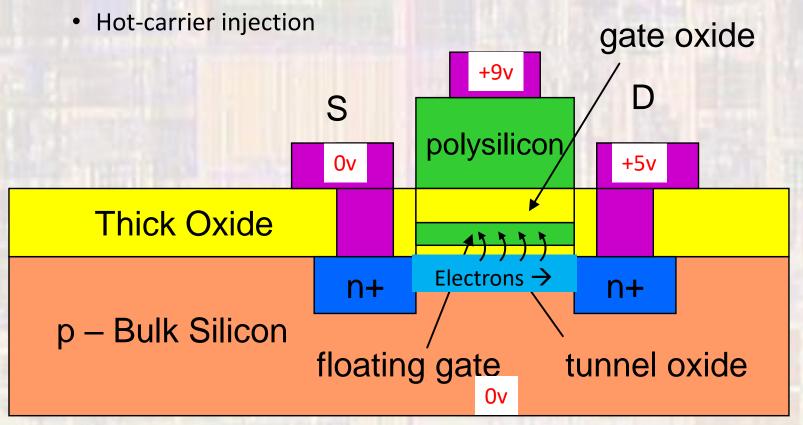
Memory Taxonomy



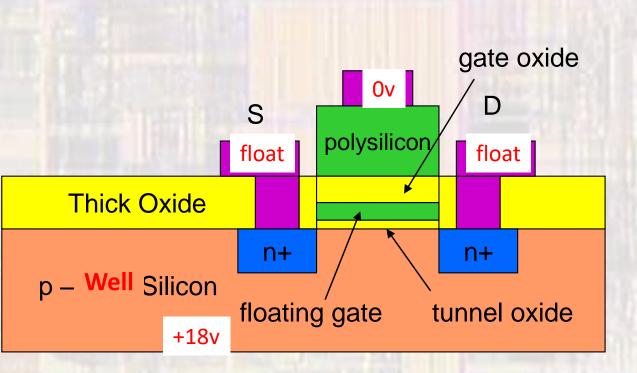
- Flash Memory basics
 - Memory cell (1 bit) is based on charge stored on a floating capacitor
 - The capacitor modifies the threshold voltage of a MOSFET
 - with negative charge stored need higher gate voltage to turn on the MOSFET
 - Creates 2 possible threshold voltages
 Different for NOR and NAND

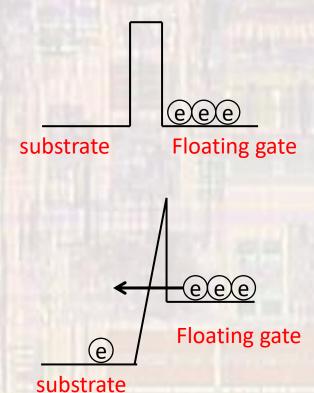


- Flash Memory NOR
 - Cell write
 - High voltage process that allows electrons to be injected into the floating gate



- Flash Memory NOR
 - Cell erase
 - High voltage process that allows electrons to tunnel out of the floating gate
 - Fowler-Nordheim Tunneling

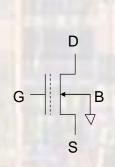


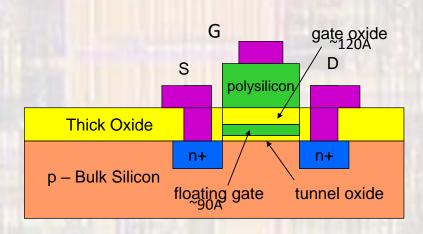


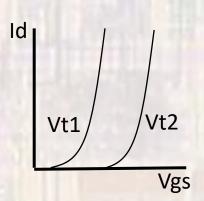
- Flash Memory NOR
 - Creates 2 possible threshold voltages

 Vth High is required to turn on the MOSFET if charge is stored

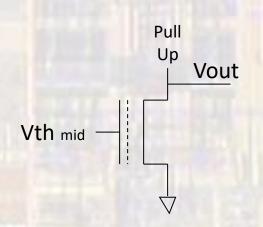
 Vth Low is required to turn on the MOSFET if no charge is stored







- Flash Memory NOR
 - Cell read
 - Place a voltage on the gate midway between Vth High and Vth Low
 - Use the circuit to determine if the MOSFET is on or off
 - Erased state no charge stored = "1"
 - Programmed state charge stored = "0"

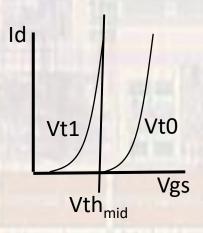


If charge stored on capacitor (programmed)

Vth_{mid} < (Vth = Vth_{High}) → Vout = high → "0"

If no charge stored on capacitor (erased)

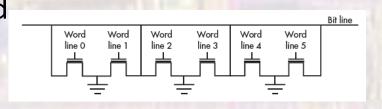
Vth_{mid} > (Vth = Vth_{Low}) → Vout = low → "1"

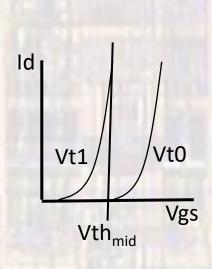


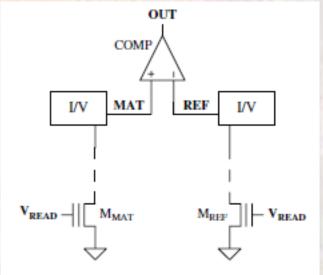
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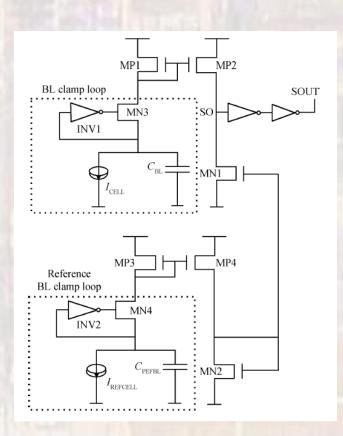
Flash Memory - NOR

• Cell read

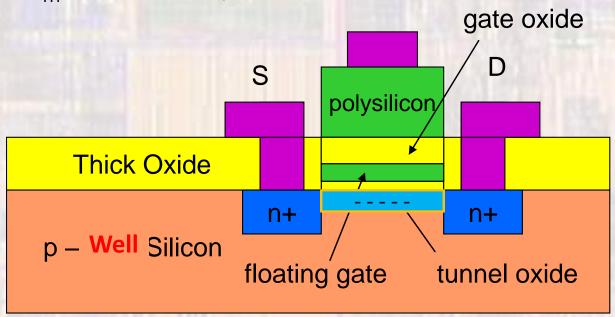






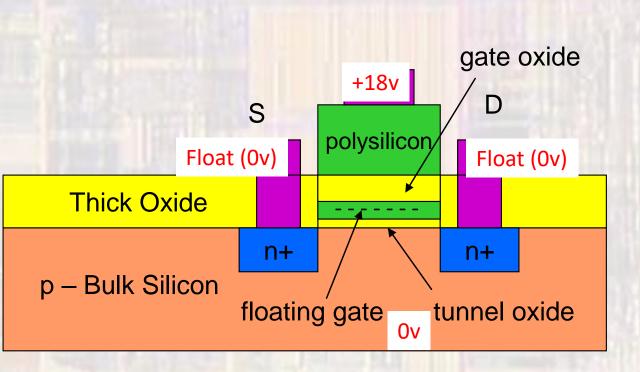


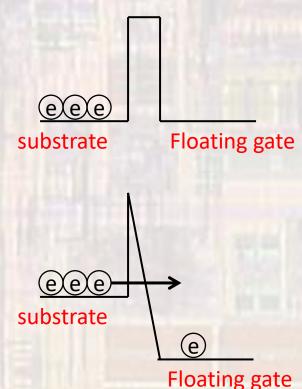
- Flash Memory NAND
 - Basic cell
 - MOSFET with a small channel when V_{GS} = 0
 - V_{TH} < 0 nominally on



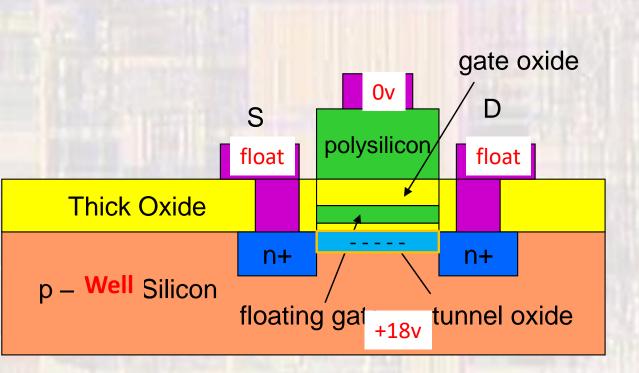
- Flash Memory NAND
 - Cell write
 - High voltage process that allows electrons to tunnel into the floating gate

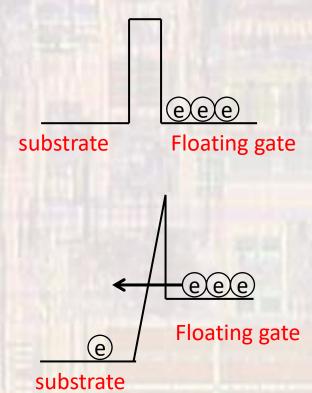
Fowler-Nordheim Tunneling



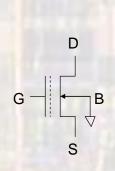


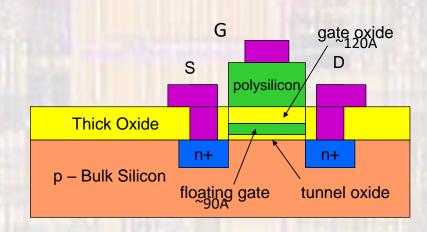
- Flash Memory NAND
 - Cell erase
 - High voltage process that allows electrons to tunnel out of the floating gate
 - Fowler-Nordheim Tunneling

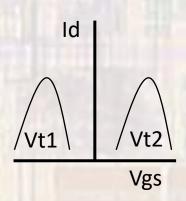




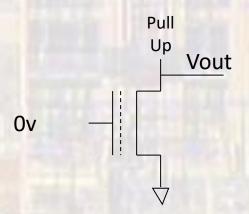
- Flash Memory NAND
 - Creates 2 possible threshold voltages
 Vth >0 is required to turn on the MOSFET if charge is stored
 Vth <0 is required to turn on the MOSFET if no charge is stored







- Flash Memory NAND
 - Cell read
 - Place 0v on the gate
 - Use the circuit to determine if the MOSFET is on or off
 - Erased state no charge stored = "1"
 - Programmed state charge stored = "0"

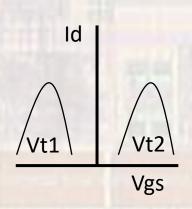


If charge stored on capacitor (programmed)

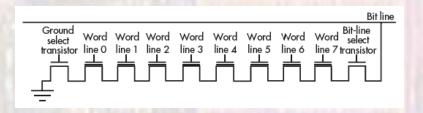
Ov < Vt2 → Vout = high → "0"

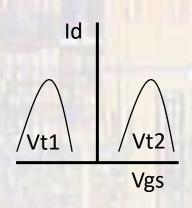
If no charge stored on capacitor (erased)

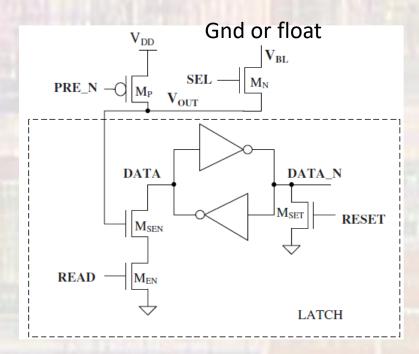
Ov > Vt1 → Vout = low → "1"



- Flash Memory NAND
 - Cell read
 - All wordlines except the desired one set high (all other cells on)
 - Only the desired cell determines if current flows or not





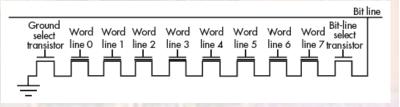


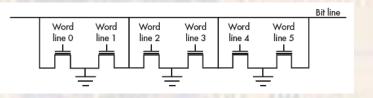
- Flash Memory
 - Programming
 - All cells start out with no charge stored = "1"
 - Individual cells can be programmed to "0"
 - A block erase is required to change cells from "0" to "1"
 - Eg.

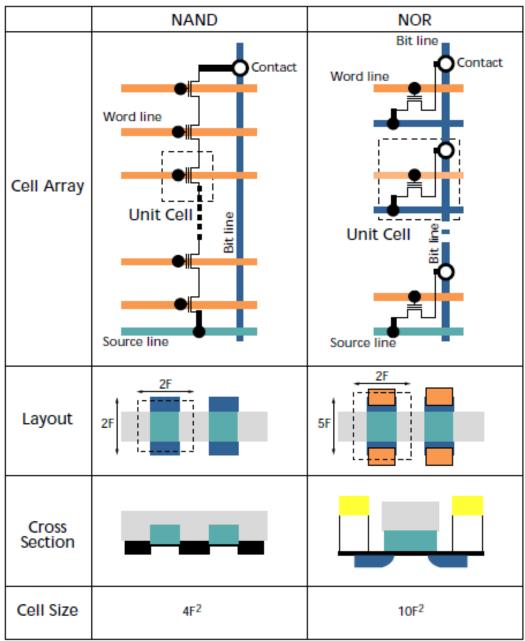
byte: 1011 1100 → 1000 1100

byte: 1011 1100 \rightarrow 1100 1100

- Flash Memory
 - Nand vs. Nor







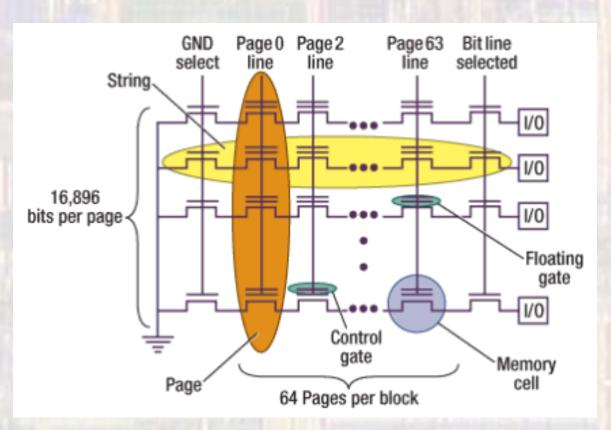
Flash Memory

- NAND Flash
 - Page Write
 - Block Erase
 - More dense
 - Fast (required) sequential access
 - Used as file storage memory (Flash Drives)

- NOR Flash
 - Byte/word Write
 - Block Erase
 - Less dense
 - Fast random access
 - Used as program memory

Flash Memory

Nand Structure



- Flash Memory
 - Damage wear out
 - The tunneling process damages the oxide layer
 - Some electrons get trapped in the oxide
 - Physical damage to the lattice
 - Limits the number of write/erase cycles
 - 10K 1M cycles
 - Wear leveling
 - Remap the external addresses to new physical blocks on erases
 - Dynamic do this as changes occur
 - Static do this to little used blocks to make them available
 - Allows all blocks to approach their failure limit

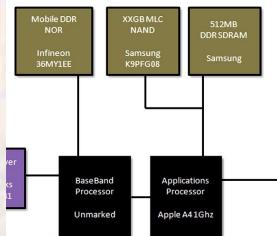
Flash Memory

- Multi-Level Cell
 - Instead of just having 2 threshold voltages allow for 4 or 8
 - 4 \rightarrow 2 bit MLC, 8 \rightarrow 3bit MLC
- Error Correction Coding ECC
 - Additional bits are used to detect and correct bit level errors in a word

- Flash Memory
 - Shadowing
 - Store large amounts of program and data in Nand Flash
 - At boot, copy a portion of the Nand memory into SRAM or SDRAM
 - Use the SRAM/SDRAM as the processor program and data memory

As additional program or data are needed – swap out a portion of

the SRAM/SDRAM



- Flash memory
 - XIP Execute in Place
 - Execute directly out of NOR flash
 - Nor Flash densities are growing rapidly
 - Nor Flash speeds are fast enough to support the memory hierarchy
 - Requires a caching system

- Other Technologies
 - Phase Change Memory PRAM
 - Ferro-Magnetic Ram FeRAM
 - Magneto-resistive Ram MRAM